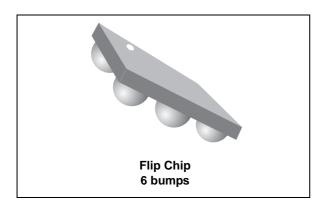


ECMF02-3F3

Common mode filter with ESD protection

Datasheet – production data



Features

- Very large differential bandwidth
- Very low PCB space consumption
- High ESD robustness: IEC 61000-4-2 level 4
- Withstand 1000 ESD strikes
- Lead-free Flip-Chip package
- Small footprint
- Very low profile

Complies with the following standard:

- IEC 61000-4-2 level 4:
 - ±15 kV (air discharge)
 - ±8 kV (contact discharge)

Applications

Where transient overvoltage protection in ESD sensitive equipment is required such as:

- Mobile phones
- Computers
- Portable navigation devices
- Digital still cameras
- Portable multimedia players

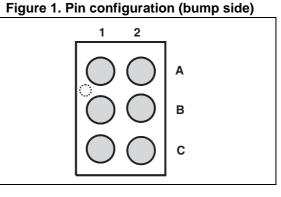
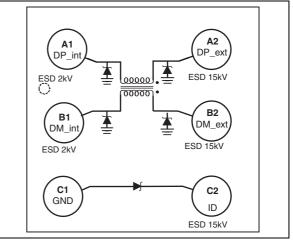


Figure 2. Schematic (bump side)



Description

The ECMF02-3F3 is a highly integrated common mode filter designed to suppress EMI/RFI common mode noise on high speed differential serial buses.

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December 2013

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This is information on a product in full production.

1 Characteristics

Symbol	Parameter	Value	Unit
V _{PP}	IEC 61000-4-2 (C = 150 pF, R = 330 Ω) External pins (A2, B2 and C2): level 4 Air discharge Contact discharge Internal pins (A1, B1): level 1 Air discharge Contact discharge	15 8 2 2	kV
Pd	Line resistance power dissipation at 85 °C (top max)	60	mW
Тj	Operating temperature range	- 30 to + 85	°C
T _{stg}	Storage temperature range	- 55 to 150	°C

Table 1. Absolute maximum ratings (T_{amb} = 25 °C)

Figure 3. Electrical characteristics	(definitions)
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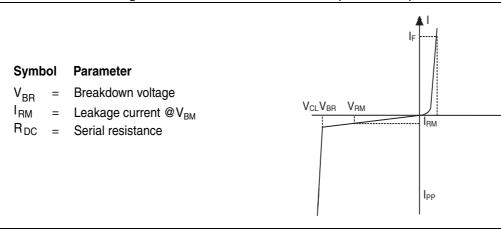


Table 2. Electrical	characteristics	(values.	$T_{amb} = 25 ^{\circ}C$
	01101 00101 151105	(Values,	amb = 20 Of

Symbol	I Test conditions		Тур.	Max.	Unit
V _{BR}	I _R = 1 mA	6			V
I _{RM}	I _{RM} V _{RM} = 3 V per line			100	nA
R _{DC}	R _{DC} DC serial resistance		3.4	4.5	Ω



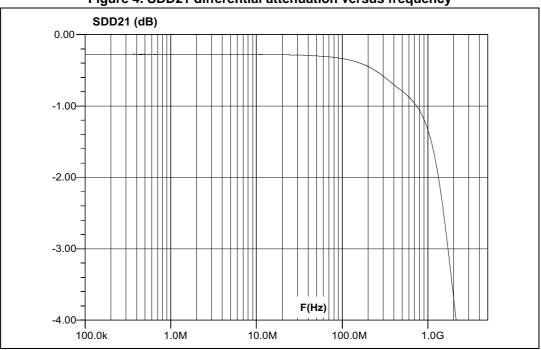
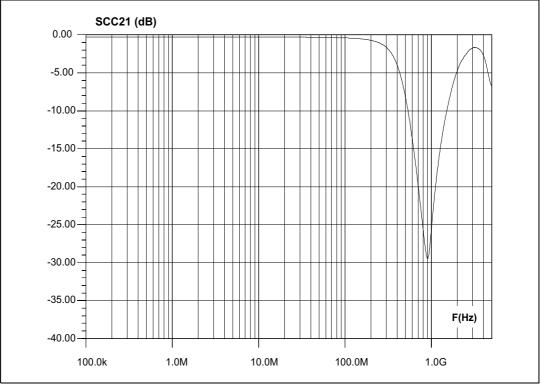


Figure 4. SDD21 differential attenuation versus frequency







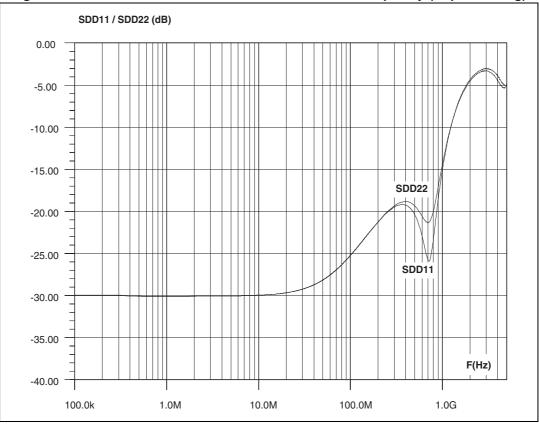


Figure 6. SDD11 / SDD22 differential return loss versus frequency (ID pin floating)

Figure 7. Eye diagram (according to USB 2.0 high speed specification mask1)

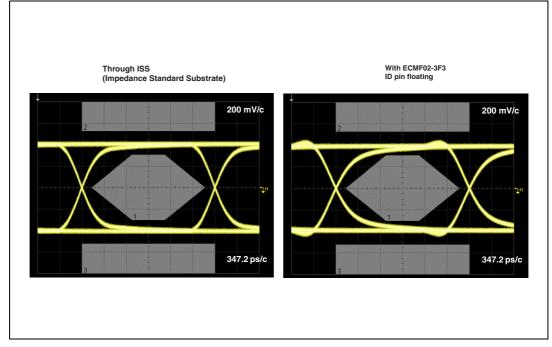
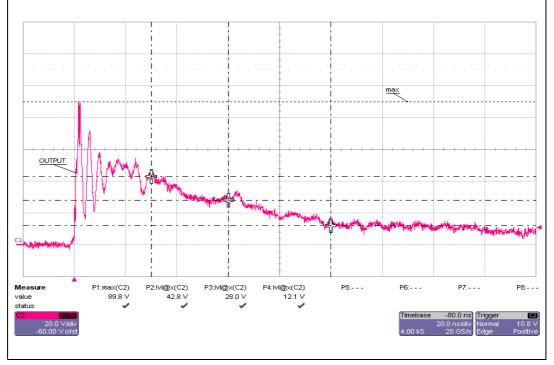






Figure 8. TDR: $Z_{0 \text{ DIFF}}$ = 100 Ω , t_{R} = 400 ps (10% - 90%),

Figure 9. ESD response to IEC 61000-4-2 (+8 kV contact discharge)





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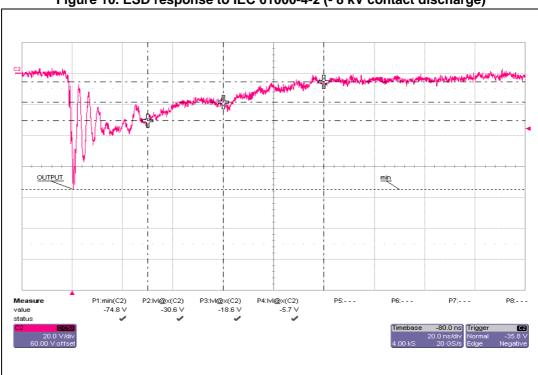


Figure 10. ESD response to IEC 61000-4-2 (- 8 kV contact discharge)



2 USB 2.0 application schematic

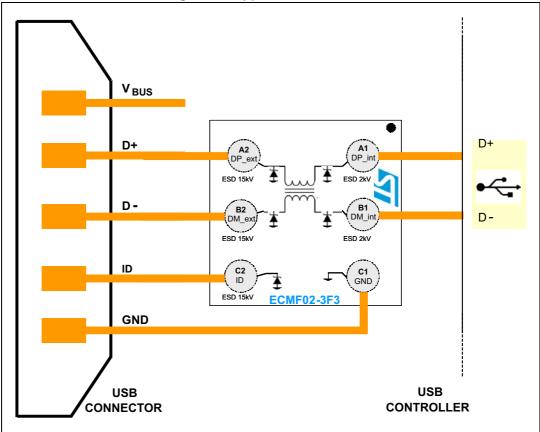


Figure 11. Application schematic



3 Ordering information scheme

Figure 12. Ordering information scheme	Figure 12.	Ordering	information	scheme
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	ECMF 02 - 3 F3
Function ESD common mode filter	
Number of lines 02 = 2 lines	
Number of ESD protected lines 3 = 3 ESD protected lines	
Package F3 = Flip Chip, 0.4 mm pitch	



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com.* ECOPACK[®] is an ST trademark.

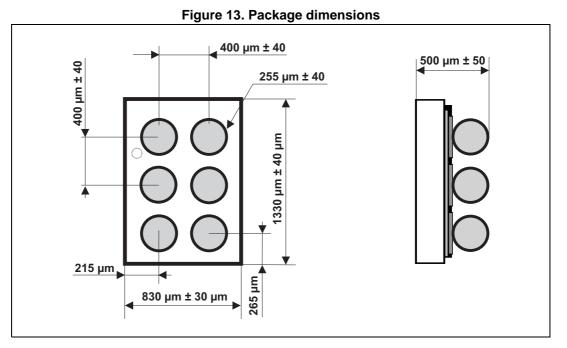
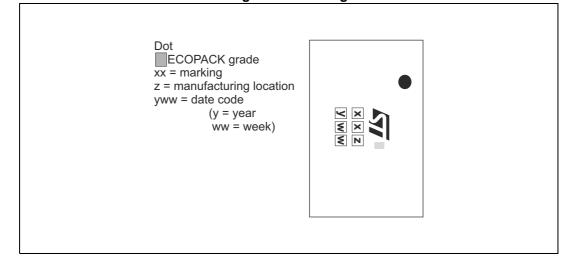
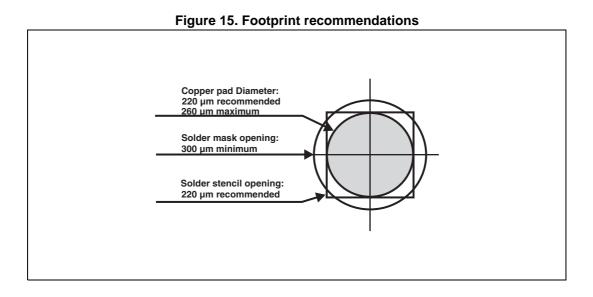
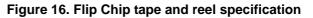
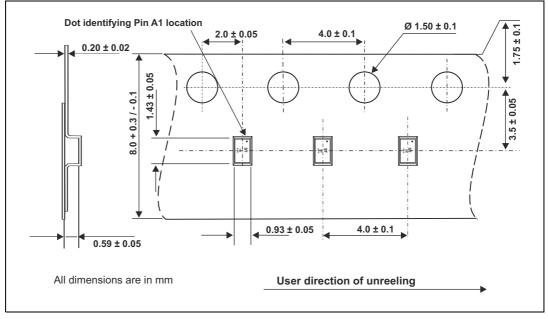


Figure 14. Marking









Note:

More information is available in the application notes: AN2348, "IPAD[™] 400 µm Flip Chip: package description and recommendations for use" AN1751, "EMI filters: recommendations and measurements"



5 Ordering information

Table 3. Ordering information					
Order code	Marking	Package	Weight	Base qty	Delivery mode
ECMF02-3F3	KH	Flip Chip	1.2 mg	5000	Tape and reel 7"

Table 3. Ordering information

6 Revision history

Table 4. Document revision history

Date	Revision	Changes
19-Nov-2012	1	Initial release.
22-May-2013	2	Moved dot position in <i>Figure 13</i> . Moved arrow in <i>Figure 16</i> to point to pin A1 location.
19-Dec-2013	3	Corrected typographical error in <i>Figure 13</i> .



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